TOSHIBA

TOSHIBA Photocoupler GaAs Ired & Photo-MOS FET

TLP176G

Modems In PC Modem-Fax Cards Telecommunications

The TOSHIBA TLP176G consists of gallium arsenide infrared emitting diode optically coupled to a photo-MOS FET in a SOP, which is suitable for surface mount assembly. The TLP176G is suitable for the modem applications which require space savings.

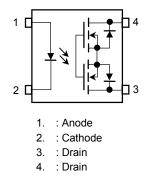
- Peak off-state voltage: 350V (min)
- Trigger LED current: 3mA (max)
- On-state resistance: 35Ω (max)
- Isolation voltage: 1500Vrms (min)
- UL recognized: UL1577, file No. E67349
- BSI approved
 - : BS EN60065: 2002, certificate No.8753
 - BS EN60950-1: 2002, certificate No.8754
- SEMKO approved: SS EN60065

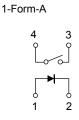
SS EN60950

• Option(V4)type

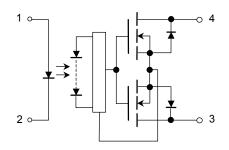
TUV approved: DIN EN 60747-5-2 Certificate No.40009351

Pin Configuration (top view)

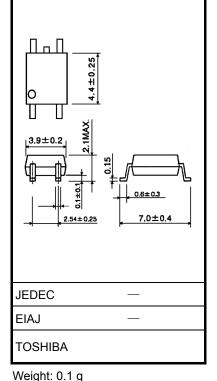




Schematic



Unit in mm



Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current	١ _F	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F / °C	-0.5	mA / °C
LED	Pulse forward current (100µs pulse,100pps)	I _{FP}	1	А
	Reverse voltage	V _R	5	V
	Junction temperature	Tj	125	°C
	Off-state output terminal voltage	VOFF	350	V
Detector	On-state current	I _{ON}	120	mA
	On–state current derating (Ta ≥ 25°C)	Δl _{ON} / °C	-1.2	mA / °C
	Junction temperature	Tj	125	°C
Total power dissipation		PT	350	mW
Total power dissupation derating(Ta ≥ 25°C)		ΔPT / °C	-0.35	mW / °C
Storage temperature range		T _{stg}	-55~125	°C
Operating temperature range		T _{opr}	-40~85	°C
Lead	Lead soldering temperature(10 s)		260	°C
Isola	Isolation voltage (AC,1 min., R.H.≤ 60%) (Note 1)		1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1): Device considered a two-terminal device: Pin 1 and 2 shorted together and pin 3 and 4 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V _{DD}	_	_	280	V
Forward current	١ _F	5	7.5	25	mA
On-state current	I _{ON}	_	_	100	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	VF	I _F = 10mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5V	_	_	10	μA
	Capacitance	CT	V = 0,f = 1MHz	_	30	_	pF
or	Off-state current	I _{OFF}	V _{OFF} = 350V	_	_	1	μA
Detector	Capacitance	C _{OFF}	V = 0,f = 1MHz		40		pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Trigger LED current	I _{FT}	I _{ON} = 120mA	—	1	3	mA
On-state resistance	R _{ON}	I _{ON} = 120mA,I _F = 5mA		22	35	Ω

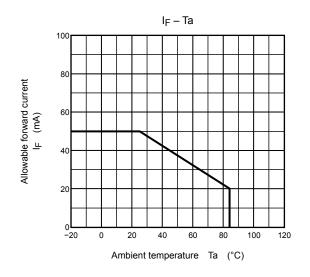
Isolation Characteristics (Ta = 25°C)

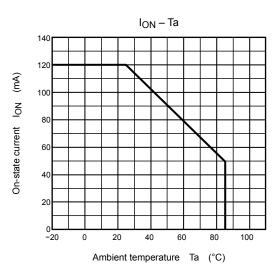
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance input to output	CS	$V_{S} = 0, f = 1MHz$	—	0.8	_	pF
Isolation resistance	R _S	V _S = 500V,R.H ≤ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
	BVS	AC, 1minute	1500	_	_	
Isolation voltage		AC, 1second (in oil)	—	3000	_	Vrms
		DC, 1minute (in oil)	—	3000		Vdc

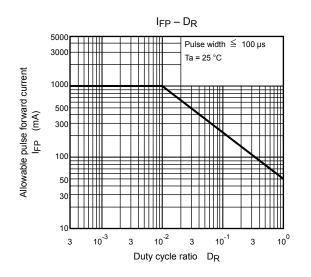
Switching Characteristics (Ta = 25°C)

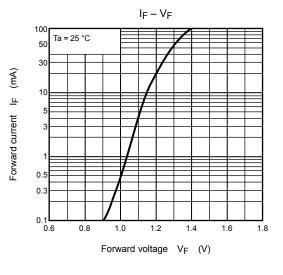
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Turn-on time	t _{ON}	R _L = 200Ω	_	0.3	1	ms
Turn-off time	tOFF	V _{CC} = 20V, I _F = 5mA	_	0.1	1	1115

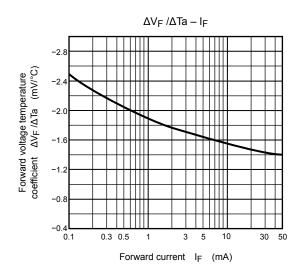
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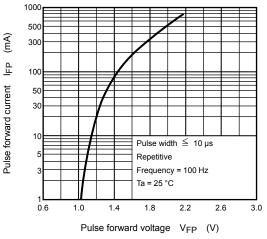




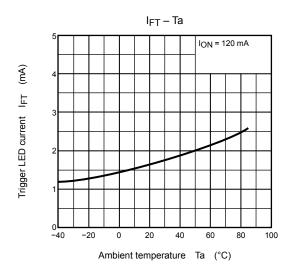


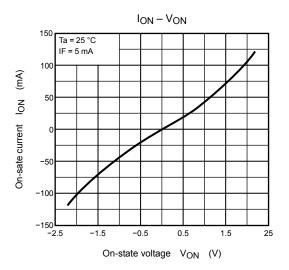


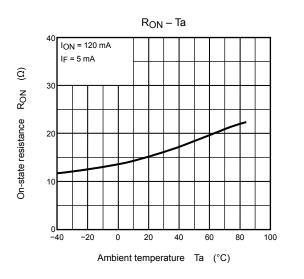


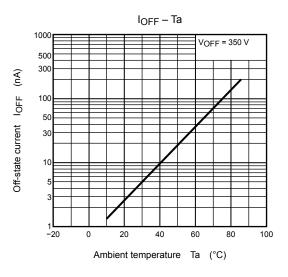


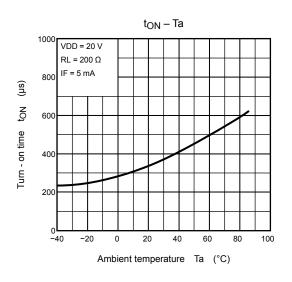
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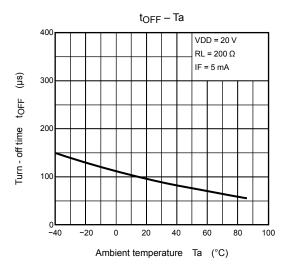


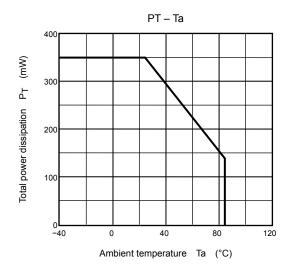












RESTRICTIONS ON PRODUCT USE

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- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
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